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Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	14KB (8K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc66t-04-so

PIC16C6X

TABLE 1-1: PIC16C6X FAMILY OF DEVICES

		PIC16C61	PIC16C62A	PIC16CR62	PIC16C63	PIC16CR63
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20
Memory	EPROM Program Memory (x14 words)	1K	2K	—	4K	—
	ROM Program Memory (x14 words)	—	—	2K	—	4K
	Data Memory (bytes)	36	128	128	192	192
Peripherals	Timer Module(s)	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Capture/Compare/PWM Module(s)	—	1	1	2	2
	Serial Port(s) (SPI/I ² C, USART)	—	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	—	—	—	—	—
Features	Interrupt Sources	3	7	7	10	10
	I/O Pins	13	22	22	22	22
	Voltage Range (Volts)	3.0-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	—	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SO	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC	28-pin SDIP, SOIC

		PIC16C64A	PIC16CR64	PIC16C65A	PIC16CR65	PIC16C66	PIC16C67
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
Memory	EPROM Program Memory (x14 words)	2K	—	4K	—	8K	8K
	ROM Program Memory (x14 words)	—	2K	—	4K	—	—
	Data Memory (bytes)	128	128	192	192	368	368
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Capture/Compare/PWM Module(s)	1	1	2	2	2	2
	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	Yes	Yes	Yes	Yes	—	Yes
Features	Interrupt Sources	8	8	11	11	10	11
	I/O Pins	33	33	33	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	Yes	Yes	Yes	Yes	Yes
	Packages	40-pin DIP; 44-pin PLCC, MQFP, TQFP	40-pin DIP; 44-pin PLCC, MQFP, TQFP	40-pin DIP; 44-pin PLCC, MQFP, TQFP	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C6X Family devices use serial programming with clock pin RB6 and data pin RB7.

PIC16C6X

FIGURE 5-4: BLOCK DIAGRAM OF THE RB7:RB4 PINS FOR PIC16C62A/63/R63/64A/65A/R65/66/67

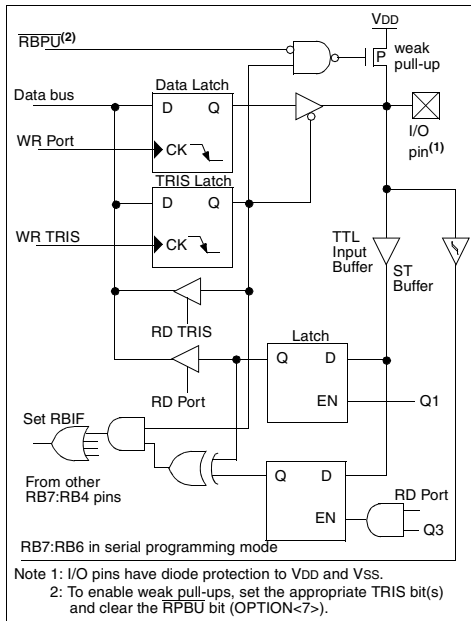


FIGURE 5-5: BLOCK DIAGRAM OF THE RB3:RB0 PINS

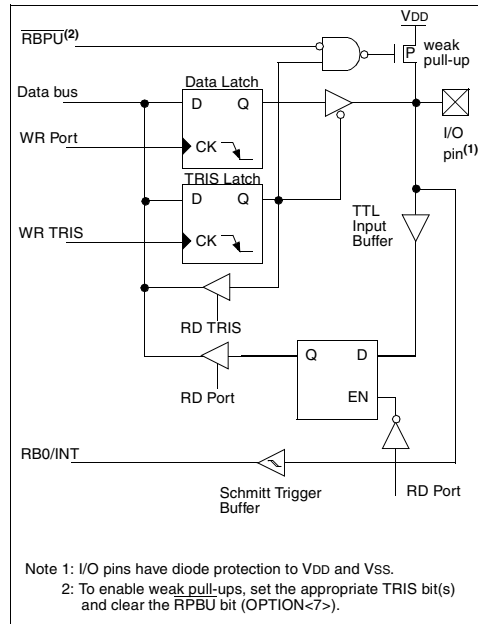


TABLE 5-3: PORTB FUNCTIONS

Name	Bit#	Buffer Type	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output pin or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming clock.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming data.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

2: This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 5-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
06h, 106h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuuu
86h, 186h	TRISB	PORTB Data Direction Register								1111 1111	1111 1111
81h, 181h	OPTION	RBPUR	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTB.

5.3 PORTC and TRISC Register

Applicable Devices															
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		

PORTC is an 8-bit wide bi-directional port. Each pin is individually configurable as an input or output through the TRISC register. PORTC is multiplexed with several peripheral functions (Table 5-5). PORTC pins have Schmitt Trigger input buffers.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. Since the TRIS bit override is in effect while the peripheral is enabled, read-modify-write instructions (BSF, BCF, XORWF) with TRISC as destination should be avoided. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

EXAMPLE 5-3: INITIALIZING PORTC

```
BCF    STATUS, RP0 ;
BCF    STATUS, RP1 ; PIC16C66/67 only
CLRF   PORTC       ; Initialize PORTC by
                   ; clearing output
                   ; data latches
BSF    STATUS, RP0 ; Select Bank 1
MOVLW  0xCF        ; Value used to
                   ; initialize data
                   ; direction
MOVWF  TRISC       ; Set RC<3:0> as inputs
                   ; RC<5:4> as outputs
                   ; RC<7:6> as inputs
```

FIGURE 5-6: PORTC BLOCK DIAGRAM

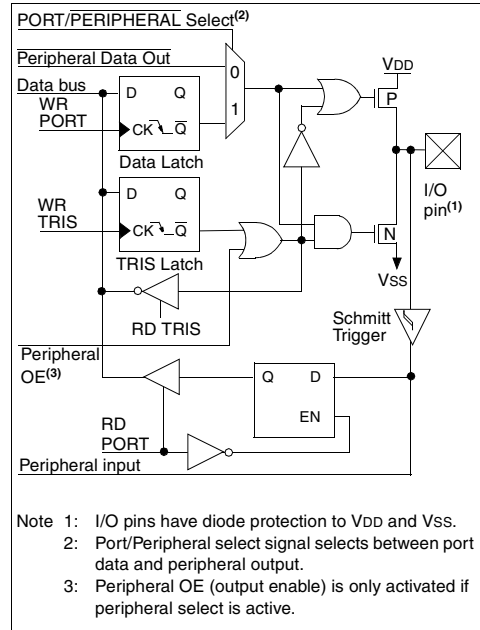


TABLE 5-5: PORTC FUNCTIONS FOR PIC16C62/64

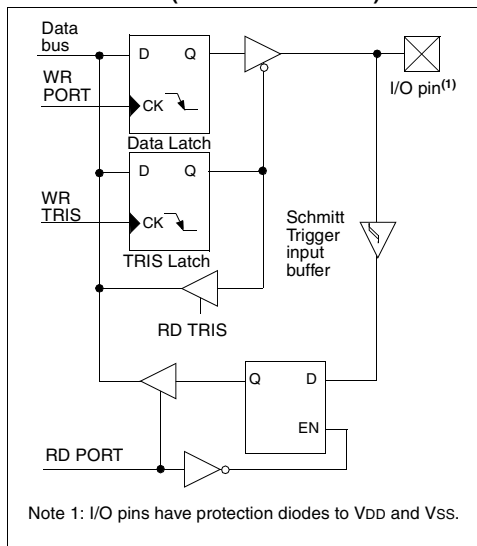
Name	Bit#	Buffer Type	Function
RC0/T1OSI/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator input or Timer1 clock input
RC1/T1OSO	bit1	ST	Input/output port pin or Timer1 oscillator output
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6	bit6	ST	Input/output port pin
RC7	bit7	ST	Input/output port pin

Legend: ST = Schmitt Trigger input

Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

I/O PORTE becomes control inputs for the microprocessor port when bit PSPMODE (TRISE<4>) is set. In this mode, the user must make sure that the TRISE<2:0> bits are set (pins are configured as digital inputs). In this mode the input buffers are TTL.

FIGURE 5-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)



R-0	R-0	R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1
IBF	OBF	IBOV	PSPMODE	—	bit2	bit1	bit0

bit7 bit0

R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'
 - n = Value at POR reset

bit 7 : **IBF**: Input Buffer Full Status bit
 1 = A word has been received and is waiting to be read by the CPU
 0 = No word has been received

bit 6: **OBF**: Output Buffer Full Status bit
 1 = The output buffer still holds a previously written word
 0 = The output buffer has been read

bit 5: **IBOV**: Input Buffer Overflow Detect bit (in microprocessor mode)
 1 = A write occurred when a previously input word has not been read (must be cleared in software)
 0 = No overflow occurred

bit 4: **PSPMODE**: Parallel Slave Port Mode Select bit
 1 = Parallel slave port mode
 0 = General purpose I/O mode

bit 3: **Unimplemented**: Read as '0'

PORTE Data Direction Bits

bit 2: **Bit2**: Direction Control bit for pin RE2/ $\overline{CS}$
 1 = Input
 0 = Output

bit 1: **Bit1**: Direction Control bit for pin RE1/ $\overline{WR}$
 1 = Input
 0 = Output

bit 0: **Bit0**: Direction Control bit for pin RE0/ $\overline{RD}$
 1 = Input
 0 = Output

8.3 Timer1 Operation in Asynchronous Counter Mode

Applicable Devices															
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		

If control bit $\overline{T1SYNC}$ ($T1CON<2>$) is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and generate an interrupt on overflow which will wake the processor. However, special precautions in software are needed to read-from or write-to the Timer1 register pair, TMR1L and TMR1H (Section 8.3.2).

In asynchronous counter mode, Timer1 cannot be used as a time-base for capture or compare operations.

8.3.1 EXTERNAL CLOCK INPUT TIMING WITH UNSYNCHRONIZED CLOCK

If control bit $\overline{T1SYNC}$ is set, the timer will increment completely asynchronously. The input clock must meet certain minimum high time and low time requirements, as specified in timing parameters (45 - 47).

8.3.2 READING AND WRITING TMR1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L, while the timer is running from an external asynchronous clock, will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself poses certain problems since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers while the register is incrementing. This may produce an unpredictable value in the timer register.

Reading the 16-bit value requires some care. Example 8-1 is an example routine to read the 16-bit timer value. This is useful if the timer cannot be stopped.

EXAMPLE 8-1: READING A 16-BIT FREE-RUNNING TIMER

```
; All Interrupts are disabled
MOVF  TMR1H, W      ;Read high byte
MOVWF  TMPH         ;
MOVF  TMR1L, W      ;Read low byte
MOVWF  TMPL         ;
MOVF  TMR1H, W      ;Read high byte
SUBWF  TMPH, W      ;Sub 1st read
                     ;with 2nd read

BTFSC  STATUS, Z     ;is result = 0
GOTO   CONTINUE      ;Good 16-bit read
; TMR1L may have rolled over between the read
; of the high and low bytes. Reading the high
; and low bytes now will read a good value.
MOVF  TMR1H, W      ;Read high byte
MOVWF  TMPH         ;
MOVF  TMR1L, W      ;Read low byte
MOVWF  TMPL         ;
; Re-enable Interrupt (if required)
CONTINUE                ;Continue with
:                        ;your code
```

8.4 Timer1 Oscillator

Applicable Devices															
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		

A crystal oscillator circuit is built in-between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN ($T1CON<3>$). The oscillator is a low power oscillator rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for a 32 kHz crystal. Table 8-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must allow a software time delay to ensure proper oscillator start-up.

TABLE 8-1: CAPACITOR SELECTION FOR THE TIMER1 OSCILLATOR

Osc Type	Freq	C1	C2
LP	32 kHz	33 pF	33 pF
	100 kHz	15 pF	15 pF
	200 kHz	15 pF	15 pF
These values are for design guidance only.			
Crystals Tested:			
32.768 kHz	Epson C-001R32.768K-A	± 20 PPM	
100 kHz	Epson C-2 100.00 KC-P	± 20 PPM	
200 kHz	STD XTL 200.000 kHz	± 20 PPM	
Note 1: Higher capacitance increases the stability of oscillator but also increases the start-up time.			
2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.			

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12.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 12-10. The data comes in the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc.

Once Asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

The heart of the receiver is the receive (serial) shift register (RSR). After sampling the STOP bit, the received data in the RSR is transferred to the RCREG register (if it is empty). If the transfer is complete, flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is cleared by the hardware. It is cleared when the RCREG register has been read and is empty. The RCREG is double buffered register, i.e., it is a two deep FIFO. It is

possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte begin shifting to the RSR register. On the detection of the STOP bit of the third byte, if the RCREG is still full, then the overrun error bit, OERR (RCSTA<1>) will be set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun bit OERR has to be cleared in software. This is done by resetting the receive logic (CREN is cleared and then set). If bit OERR is set, transfers from the RSR register to the RCREG register are inhibited, so it is essential to clear overrun bit OERR if it is set. Framing error bit FERR (RCSTA<2>) is set if a stop bit is detected as clear. Error bit FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG register will load bits RX9D and FERR with new values. Therefore it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

FIGURE 12-10: USART RECEIVE BLOCK DIAGRAM

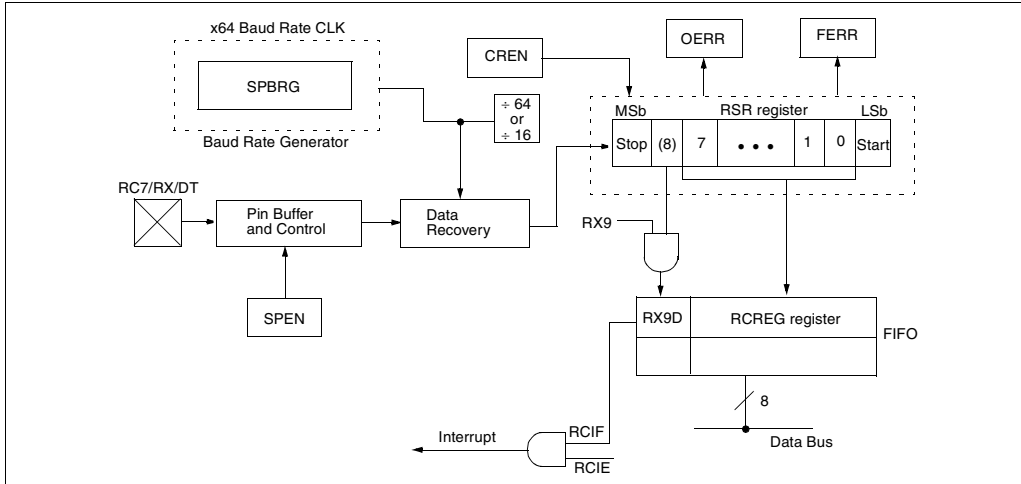


FIGURE 12-11: ASYNCHRONOUS RECEPTION

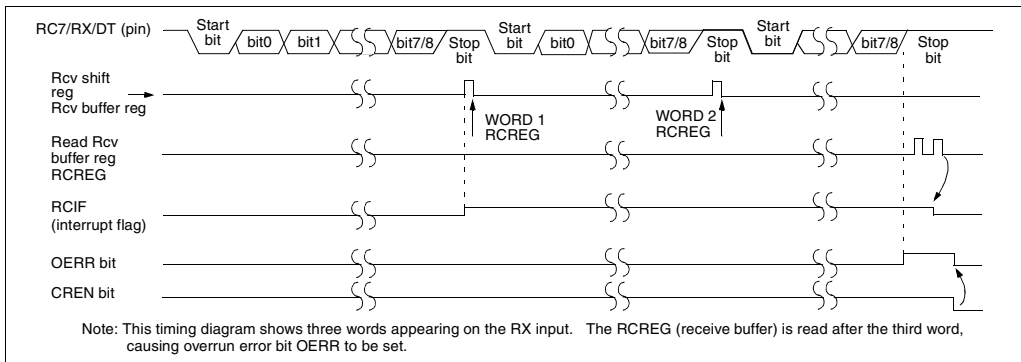


TABLE 13-9: STATUS BITS AND THEIR SIGNIFICANCE FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

POR	BOR	TO	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on a Power-on Reset
0	x	x	0	Illegal, PD is set on a Power-on Reset
1	0	x	x	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR reset during normal operation
1	1	1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

Legend: x = unknown, u = unchanged

TABLE 13-10: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C61/62/64/65

	Program Counter	STATUS	PCON ⁽²⁾
Power-on Reset	000h	0001 1xxx	---- --0-
MCLR reset during normal operation	000h	000u uuuu	---- --u-
MCLR reset during SLEEP	000h	0001 0uuu	---- --u-
WDT Reset	000h	0000 1uuu	---- --u-
WDT Wake-up	PC + 1	uuu0 0uuu	---- --u-
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	---- --u-

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

2: The PCON register is not implemented on the PIC16C61.

TABLE 13-11: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

	Program Counter	STATUS	PCON
Power-on Reset	000h	0001 1xxx	---- --0x
MCLR reset during normal operation	000h	000u uuuu	---- --uu
MCLR reset during SLEEP	000h	0001 0uuu	---- --uu
WDT Reset	000h	0000 1uuu	---- --uu
Brown-out Reset	000h	0001 1uuu	---- --u0
WDT Wake-up	PC + 1	uuu0 0uuu	---- --uu
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	---- --uu

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

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TABLE 14-2: PIC16CXX INSTRUCTION SET

Mnemonic, Operands	Description	Cycles	14-Bit Opcode		Status Affected	Notes	
			MSb	LSb			
BYTE-ORIENTED FILE REGISTER OPERATIONS							
ADDWF	f, d	Add W and f	1	00	0111 dfff ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101 dfff ffff	Z	1,2
CLRF	f	Clear f	1	00	0001 1fff ffff	Z	2
CLRW	-	Clear W	1	00	0001 0xxx xxxx	Z	
COMF	f, d	Complement f	1	00	1001 dfff ffff	Z	1,2
DECf	f, d	Decrement f	1	00	0011 dfff ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011 dfff ffff		1,2,3
INCF	f, d	Increment f	1	00	1010 dfff ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111 dfff ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100 dfff ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000 dfff ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000 1fff ffff		
NOP	-	No Operation	1	00	0000 0xx0 0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101 dfff ffff	C	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100 dfff ffff	C	1,2
SUBWF	f, d	Subtract W from f	1	00	0010 dfff ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110 dfff ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110 dfff ffff	Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS							
BCF	f, b	Bit Clear f	1	01	00bb bfff ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb bfff ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb bfff ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb bfff ffff		3
LITERAL AND CONTROL OPERATIONS							
ADDLW	k	Add literal and W	1	11	111x kkkk kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001 kkkk kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk kkkk kkkk		
CLRWDT	-	Clear Watchdog Timer	1	00	0000 0110 0100	$\overline{TO}, \overline{PD}$	
GOTO	k	Go to address	2	10	1kkk kkkk kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000 kkkk kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx kkkk kkkk		
RETFIE	-	Return from interrupt	2	00	0000 0000 1001		
RETLW	k	Return with literal in W	2	11	01xx kkkk kkkk		
RETURN	-	Return from Subroutine	2	00	0000 0000 1000		
SLEEP	-	Go into standby mode	1	00	0000 0110 0011	$\overline{TO}, \overline{PD}$	
SUBLW	k	Subtract W from literal	1	11	110x kkkk kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010 kkkk kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)					
		Operating temperature -40°C ≤ TA ≤ +125°C for extended, -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial					
		Operating voltage VDD range as described in DC spec Section 15.1 and Section 15.2.					
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D090	Output High Voltage I/O ports (Note 3)	VOH	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D090A			VDD-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5V, -40°C to +125°C
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C
D092A			VDD-0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V, -40°C to +125°C
D150*	Open-Drain High Voltage	VOD	-	-	14	V	RA4 pin
Capacitive Loading Specs on Output Pins							
D100	OSC2 pin	COSC2			15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	CIO			50	pF	

* The parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 15-5: TIMER0 EXTERNAL CLOCK TIMINGS

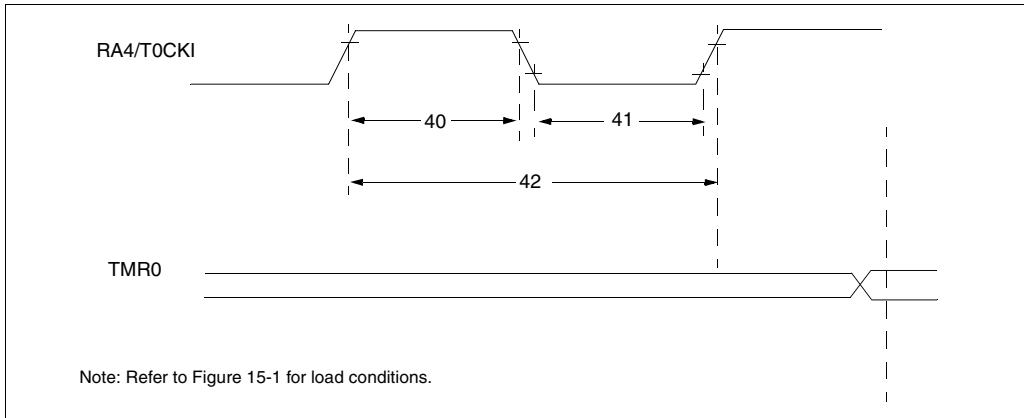


TABLE 15-5: TIMER0 EXTERNAL CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 42
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 42
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period	No Prescaler	$T_{CY} + 40$	—	—	ns	N = prescale value (2, 4, ..., 256)
			With Prescaler	Greater of: 20 ns or $\frac{T_{CY} + 40}{N}$	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67
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NOTES:

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

18.3 DC Characteristics: **PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended)**
PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended)
PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended)
PIC16LC62A/R62/64A/R64-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)							
DC CHARACTERISTICS		Operating temperature					
		-40°C ≤ TA ≤ +125°C for extended,					
		-40°C ≤ TA ≤ +85°C for industrial and					
		0°C ≤ TA ≤ +70°C for commercial					
		Operating voltage VDD range as described in DC spec Section 18.1 and Section 18.2					
Param No.	Characteristic	Sym	Min	Typ †	Max	Units	Conditions
D030 D030A D031 D032 D033	Input Low Voltage I/O ports	VIL					
	with TTL buffer		VSS	-	0.15VDD	V	For entire VDD range
			VSS	-	0.8V	V	4.5V ≤ VDD ≤ 5.5V
	with Schmitt Trigger buffer		VSS	-	0.2VDD	V	
	MCLR, OSC1 (in RC mode)		VSS	-	0.2VDD	V	
D040 D040A D041 D042 D042A D043	OSC1 (in XT, HS and LP)	VIH	VSS	-	0.3VDD	V	Note1
	Input High Voltage I/O ports						
	with TTL buffer		2.0	-	VDD	V	4.5V ≤ VDD ≤ 5.5V
			0.25VDD	-	VDD	V	For entire VDD range
			+ 0.8V				
D041 D042 D042A D043	with Schmitt Trigger buffer		0.8VDD	-	VDD	V	For entire VDD range
	MCLR		0.8VDD	-	VDD	V	
	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	400	µA	VDD = 5V, VPIN = VSS
D060 D061 D063	Input Leakage Current (Notes 2, 3) I/O ports	IIL	-	-	±1	µA	VSS ≤ VPIN ≤ VDD, Pin at hi-impedance
	MCLR, RA4/T0CKI		-	-	±5	µA	VSS ≤ VPIN ≤ VDD
	OSC1		-	-	±5	µA	VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
D080 D080A D083 D083A	Output Low Voltage I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 18-11: I²C BUS DATA TIMING

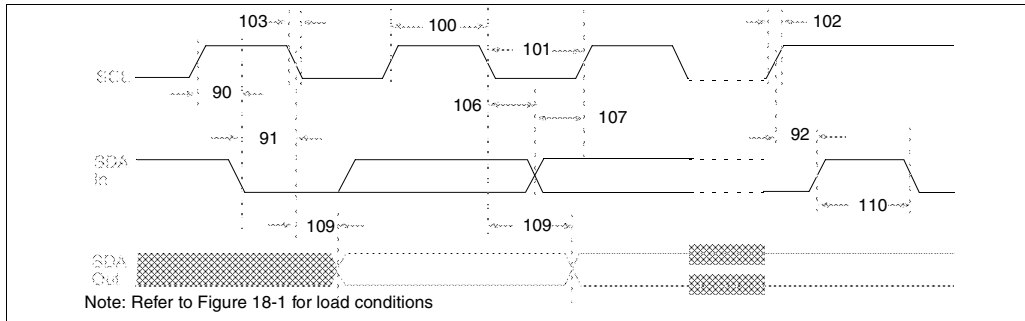


TABLE 18-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	THIGH	Clock high time	100 kHz mode	4.0	—	μs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	—	μs	Device must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	—		
101*	TLOW	Clock low time	100 kHz mode	4.7	—	μs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	—	μs	Device must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	—		
102*	TR	SDA and SCL rise time	100 kHz mode	—	1000	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	—	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	TSU:STA	START condition setup time	100 kHz mode	4.7	—	μs	Only relevant for repeated START condition
			400 kHz mode	0.6	—	μs	
91*	THD:STA	START condition hold time	100 kHz mode	4.0	—	μs	After this period the first clock pulse is generated
			400 kHz mode	0.6	—	μs	
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
92*	TSU:STO	STOP condition setup time	100 kHz mode	4.7	—	μs	
			400 kHz mode	0.6	—	μs	
109*	TAA	Output valid from clock	100 kHz mode	—	3500	ns	Note 1
			400 kHz mode	—	—	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	μs	
	Cb	Bus capacitive loading		—	400	pF	

* These parameters are characterized but not tested.

- Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- Note 2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line Tr max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

19.0 ELECTRICAL CHARACTERISTICS FOR PIC16C65

Absolute Maximum Ratings †

Ambient temperature under bias.....	-55°C to +85°C
Storage temperature	-65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, MCLR, and RA4).....	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3V to +7.5V
Voltage on MCLR with respect to VSS (Note 2).....	0V to +14V
Voltage on RA4 with respect to VSS	0V to +14V
Total power dissipation (Note 1).....	1.0W
Maximum current out of VSS pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, Iik (VI < 0 or VI > VDD).....	±20 mA
Output clamp current, Iok (VO < 0 or VO > VDD)	±20 mA
Maximum output current sunk by any I/O pin.....	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined).....	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA

Note 1: Power dissipation is calculated as follows: $P_{dis} = VDD \times \{I_{DD} - \sum I_{OH}\} + \sum \{(VDD - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

Note 2: Voltage spikes below VSS at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a “low” level to the MCLR pin rather than pulling this pin directly to VSS.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 19-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

OSC	PIC16C65-04	PIC16C65-10	PIC16C65-20	PIC16LC65-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V IPD: 1.0 µA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 µA typ. at 32 kHz, 4.0V IPD: 0.9 µA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 105 µA max. at 32 kHz, 3.0V IPD: 800 µA max. at 3.0V Freq: 200 kHz max.	VDD: 3.0V to 6.0V IDD: 105 µA max. at 32 kHz, 3.0V IPD: 800 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

FIGURE 21-9: SPI MODE TIMING

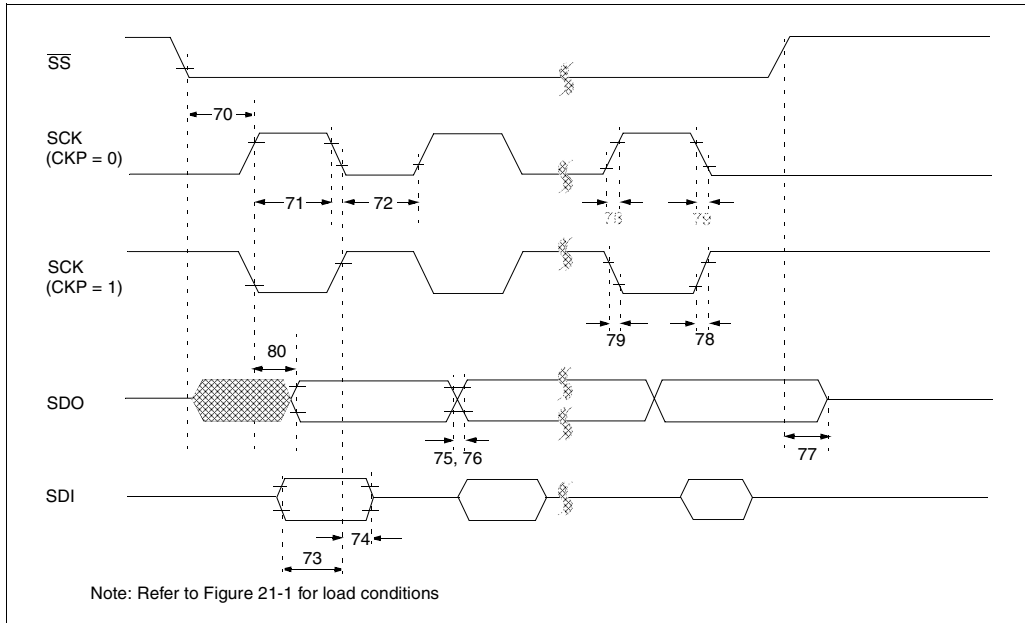


TABLE 21-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70*	Tssl2scH, Tssl2scL	$\overline{SS}\downarrow$ to SCK $\downarrow$ or SCK $\uparrow$ input	Tcy	—	—	ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	—	—	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	—	—	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	—	—	ns	
74*	Tsch2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	—	—	ns	
75*	TdoR	SDO data output rise time	—	10	25	ns	
76*	TdoF	SDO data output fall time	—	10	25	ns	
77*	TssH2doZ	$\overline{SS}\uparrow$ to SDO output hi-impedance	10	—	50	ns	
78*	TscR	SCK output rise time (master mode)	—	10	25	ns	
79*	TscF	SCK output fall time (master mode)	—	10	25	ns	
80*	Tsch2doV, TscL2doV	SDO data output valid after SCK edge	—	—	50	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-11: I²C BUS DATA TIMING

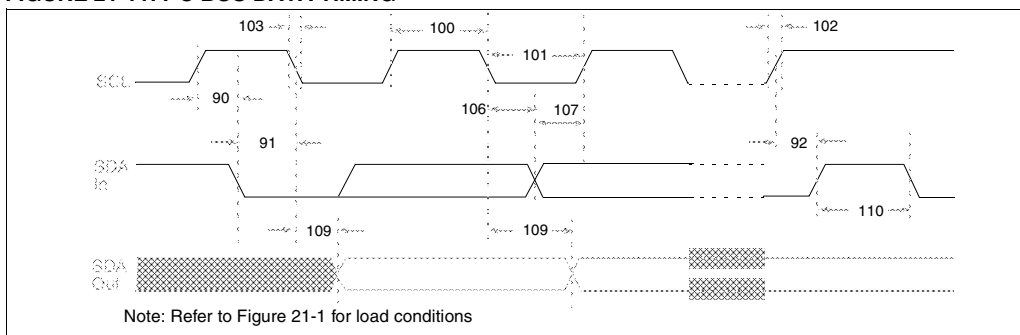


TABLE 21-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Max	Units	Conditions
100*	THIGH	Clock high time	100 kHz mode	4.0	—	μs
			400 kHz mode	0.6	—	μs
			SSP Module	1.5Tcy	—	
101*	TLOW	Clock low time	100 kHz mode	4.7	—	μs
			400 kHz mode	1.3	—	μs
			SSP Module	1.5Tcy	—	
102*	TR	SDA and SCL rise time	100 kHz mode	—	1000	ns
			400 kHz mode	20 + 0.1Cb	300	ns
103*	TF	SDA and SCL fall time	100 kHz mode	—	300	ns
			400 kHz mode	20 + 0.1Cb	300	ns
90*	TSU:STA	START condition setup time	100 kHz mode	4.7	—	μs
			400 kHz mode	0.6	—	μs
91*	THD:STA	START condition hold time	100 kHz mode	4.0	—	μs
			400 kHz mode	0.6	—	μs
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns
			400 kHz mode	0	0.9	μs
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns
			400 kHz mode	100	—	ns
92*	TSU:STO	STOP condition setup time	100 kHz mode	4.7	—	μs
			400 kHz mode	0.6	—	μs
109*	TAA	Output valid from clock	100 kHz mode	—	3500	ns
			400 kHz mode	—	—	ns
110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs
			400 kHz mode	1.3	—	μs
	Cb	Bus capacitive loading	—	400	pF	

* These parameters are characterized but not tested.

- Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- Note 2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu:DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

22.5 Timing Diagrams and Specifications

FIGURE 22-2: EXTERNAL CLOCK TIMING

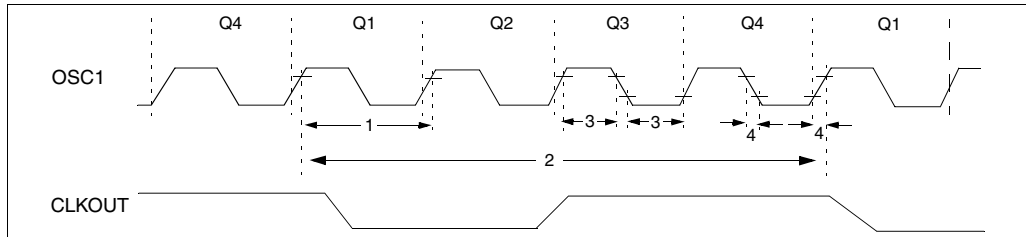


TABLE 22-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency (Note 1)	DC	—	4	MHz	XT and RC osc mode
			DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency (Note 1)	DC	—	4	MHz	RC osc mode
			0.1	—	4	MHz	XT osc mode
			4	—	20	MHz	HS osc mode
			5	—	200	kHz	LP osc mode
			5	—	200	kHz	LP osc mode
1	Tosc	External CLKIN Period (Note 1)	250	—	—	ns	XT and RC osc mode
			250	—	—	ns	HS osc mode (-04)
			100	—	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		Oscillator Period (Note 1)	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	250	ns	HS osc mode (-20)
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
			200	Tcy	DC	ns	Tcy = 4/Fosc
3*	TosL, TosH	External Clock in (OSC1) High or Low Time	100	—	—	ns	XT oscillator
			2.5	—	—	μs	LP oscillator
			15	—	—	ns	HS oscillator
4*	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	—	—	25	ns	XT oscillator
			—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 22-8: PARALLEL SLAVE PORT TIMING (PIC16C67)

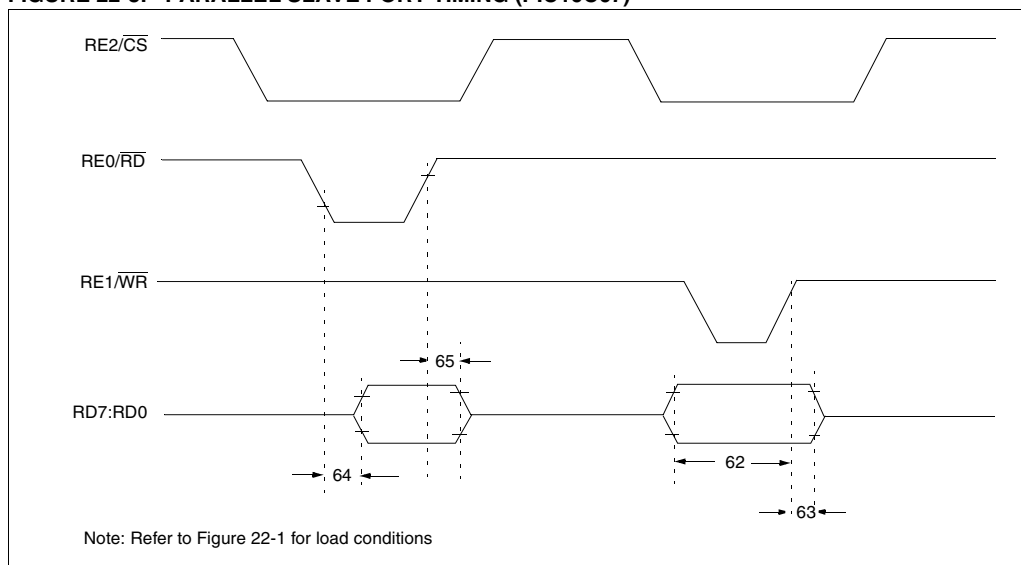


TABLE 22-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C67)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before $\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ (setup time)	20	—	—	ns	Extended Range Only
			25	—	—	ns	
63*	TwrH2dtI	$\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ to data-in invalid (hold time)	PIC16C67 20	—	—	ns	
			PIC16LC67 35	—	—	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data-out valid	—	—	80	ns	Extended Range Only
			—	—	90	ns	
65*	TrdH2dtI	$\overline{RD}\uparrow$ or $\overline{CS}\uparrow$ to data-out invalid	10	—	30	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

APPENDIX A: MODIFICATIONS

The following are the list of modifications over the PIC16C5X microcontroller family:

1. Instruction word length is increased to 14-bits. This allows larger page sizes both in program memory (2K now as opposed to 512 before) and register file (128 bytes now versus 32 bytes before).
2. A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
3. Data memory paging is redefined slightly. STATUS register is modified.
4. Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW. Two instructions TRIS and OPTION are being phased out although they are kept for compatibility with PIC16C5X.
5. OPTION and TRIS registers are made addressable.
6. Interrupt capability is added. Interrupt vector is at 0004h.
7. Stack size is increased to 8 deep.
8. Reset vector is changed to 0000h.
9. Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
10. Wake-up from SLEEP through interrupt is added.
11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT), are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
12. PORTB has weak pull-ups and interrupt on change feature.
13. Timer0 pin is also a port pin (RA4/T0CKI) now.
14. FSR is made a full 8-bit register.
15. "In-circuit programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, VSS, VPP, RB6 (clock) and RB7 (data in/out).
16. Power Control register (PCON) is added with a Power-on Reset status bit ($\overline{\text{POR}}$). (Not on the PIC16C61).
17. Brown-out Reset has been added to the following devices:
PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
5. Change reset vector to 0000h.

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